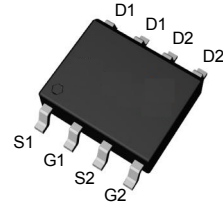


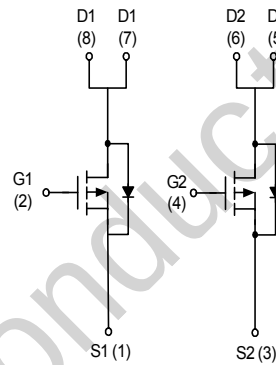
## Features

- 30V/-6.5A ,  
 $R_{DS(ON)} = 36m\Omega (typ.) @ V_{GS} = -10V$   
 $R_{DS(ON)} = 50m\Omega (typ.) @ V_{GS} = -4.5V$
- Reliable and Rugged
- Lead Free and Green Device Available  
(RoHS Compliant)
- ESD Protection

## Pin Description



Top View of SOP-8



P-Channel MOSFET

## Applications

- Power Management in Notebook Computer,  
Portable Equipment and Battery Powered  
Systems

## Electrical Characteristics (Cont.) (T<sub>A</sub> = 25°C unless otherwise noted)

| Symbol                               | Parameter                    | Test Condition                                                                                                     |      |      |      | Unit |
|--------------------------------------|------------------------------|--------------------------------------------------------------------------------------------------------------------|------|------|------|------|
|                                      |                              |                                                                                                                    | Min. | Typ. | Max. |      |
| Dynamic Characteristics <sup>b</sup> |                              |                                                                                                                    |      |      |      |      |
| R <sub>G</sub>                       | Gate Resistance              | V <sub>GS</sub> =0V, V <sub>DS</sub> =0V, F=1MHz                                                                   | -    | 8    | -    | Ω    |
| C <sub>iss</sub>                     | Input Capacitance            | V <sub>GS</sub> =0V,<br>V <sub>DS</sub> =-15V,<br>Frequency=1.0MHz                                                 | -    | 625  | -    | pF   |
| C <sub>oss</sub>                     | Output Capacitance           |                                                                                                                    | -    | 100  | -    |      |
| C <sub>rss</sub>                     | Reverse Transfer Capacitance |                                                                                                                    | -    | 60   | -    |      |
| t <sub>d(ON)</sub>                   | Turn-on Delay Time           | V <sub>DD</sub> =-15V, R <sub>L</sub> =15Ω,<br>I <sub>DS</sub> =-1A, V <sub>GEN</sub> =-10V,<br>R <sub>G</sub> =6Ω | -    | 6    | 12   | ns   |
| t <sub>r</sub>                       | Turn-on Rise Time            |                                                                                                                    | -    | 12   | 23   |      |
| t <sub>d(OFF)</sub>                  | Turn-off Delay Time          |                                                                                                                    | -    | 25   | 46   |      |
| t <sub>f</sub>                       | Turn-off Fall Time           |                                                                                                                    | -    | 6    | 12   |      |
| t <sub>rr</sub>                      | Reverse Recovery Time        | I <sub>DS</sub> =-4.9A,                                                                                            | -    | 14   | -    | ns   |
| Q <sub>rr</sub>                      | Reverse Recovery Charge      | di <sub>SD</sub> /dt=100A/μs                                                                                       | -    | 5    | -    | nC   |

Notes:

a : Pulse test ; pulse width≤300μs, duty cycle≤2%.

b : Guaranteed by design, not subject to production testing

## Absolute Maximum Ratings ( $T_A = 25^\circ\text{C}$ unless otherwise noted)

| Symbol            | Parameter                              | Rating                           | Unit               |
|-------------------|----------------------------------------|----------------------------------|--------------------|
| $V_{DSS}$         | Drain-Source Voltage                   | -30                              | V                  |
| $V_{GSS}$         | Gate-Source Voltage                    | $\pm 20$                         |                    |
| $I_D^*$           | Continuous Drain Current               | $V_{GS} = -10\text{V}$<br>-6.5   | A                  |
| $I_{DM}^*$        | Pulsed Drain Current                   |                                  |                    |
| $I_S^*$           | Diode Continuous Forward Current       | -2                               | A                  |
| $T_J$             | Maximum Junction Temperature           | 150                              | $^\circ\text{C}$   |
| $T_{STG}$         | Storage Temperature Range              | -55 to 150                       |                    |
| $P_D^*$           | Power Dissipation for Single Operation | $T_A = 25^\circ\text{C}$<br>2    | W                  |
|                   |                                        | $T_A = 100^\circ\text{C}$<br>0.8 |                    |
| $R_{\theta JA}^*$ | Thermal Resistance-Junction to Ambient | 62.5                             | $^\circ\text{C/W}$ |

Note:

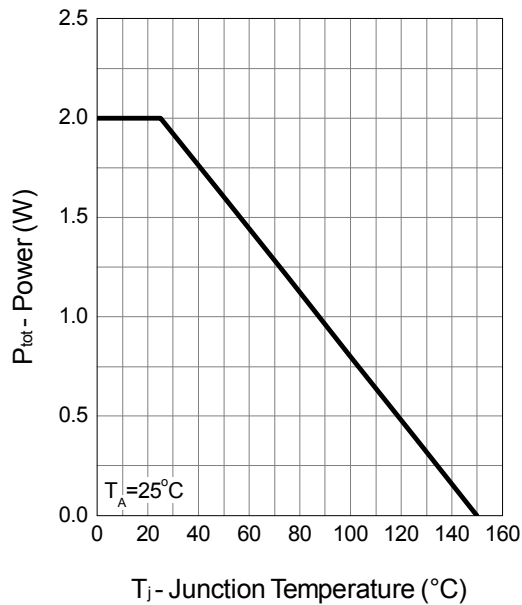
\*Surface Mounted on  $1\text{in}^2$  pad area,  $t \leq 10\text{sec}$ .

## Electrical Characteristics ( $T_A = 25^\circ\text{C}$ unless otherwise noted)

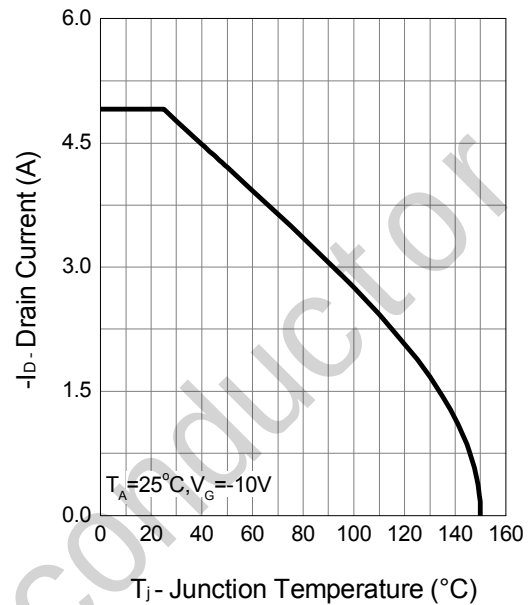
| Symbol                                   | Parameter                        | Test Condition                                                       | HM4803 |      |      | Unit |
|------------------------------------------|----------------------------------|----------------------------------------------------------------------|--------|------|------|------|
|                                          |                                  |                                                                      | Min.   | Typ. | Max. |      |
| Static Characteristics                   |                                  |                                                                      |        |      |      |      |
| BV <sub>DSS</sub>                        | Drain-Source Breakdown Voltage   | V <sub>GS</sub> =0V, I <sub>DS</sub> =250μA                          | -30    | -    | -    | V    |
| I <sub>DSS</sub>                         | Zero Gate Voltage Drain Current  | V <sub>DS</sub> =-24V, V <sub>GS</sub> =0V                           | -      | -    | -1   | μA   |
|                                          |                                  | T <sub>J</sub> =85°C                                                 | -      | -    | -30  |      |
| V <sub>GS(th)</sub>                      | Gate Threshold Voltage           | V <sub>DS</sub> =V <sub>GS</sub> , I <sub>DS</sub> =250μA            | -1     | -1.5 | -2.3 | V    |
| I <sub>GSS</sub>                         | Gate Leakage Current             | V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V                           | -      | -    | ±100 | nA   |
| R <sub>DS(ON)</sub> <sup>a</sup>         | Drain-Source On-state Resistance | V <sub>GS</sub> =-10V, I <sub>DS</sub> =-6.5A                        | -      | 36   | 45   | mΩ   |
|                                          |                                  | V <sub>GS</sub> =-4.5V, I <sub>DS</sub> =-5.6A                       | -      | 50   | 65   |      |
| V <sub>SD</sub> <sup>a</sup>             | Diode Forward Voltage            | I <sub>SD</sub> =-1.7A, V <sub>GS</sub> =0V                          | -      | -0.8 | -1.3 | V    |
| Gate Charge Characteristics <sup>b</sup> |                                  |                                                                      |        |      |      |      |
| Q <sub>g</sub>                           | Total Gate Charge                | V <sub>DS</sub> =-15V, V <sub>GS</sub> =-10V, I <sub>DS</sub> =-4.9A | -      | 11.6 | 16   | nC   |
| Q <sub>gs</sub>                          | Gate-Source Charge               |                                                                      | -      | 1.3  | -    |      |
| Q <sub>gd</sub>                          | Gate-Drain Charge                |                                                                      | -      | 2.5  | -    |      |

## Typical Characteristics

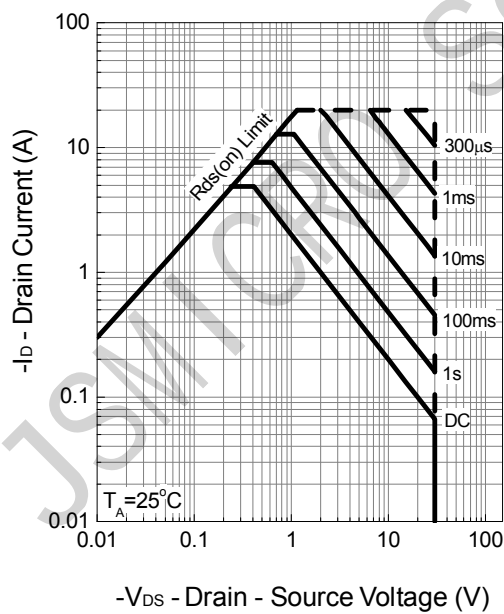
**Power Dissipation**



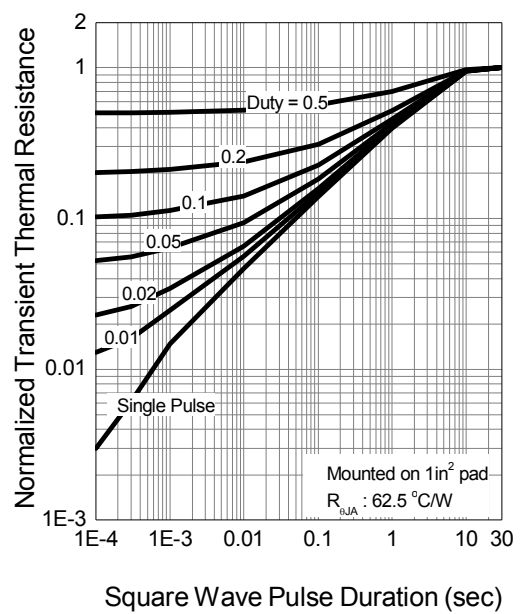
**Drain Current**



**Safe Operation Area**

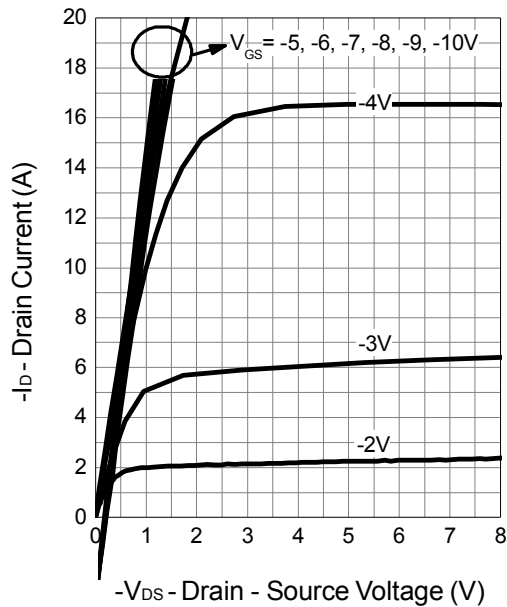


**Thermal Transient Impedance**

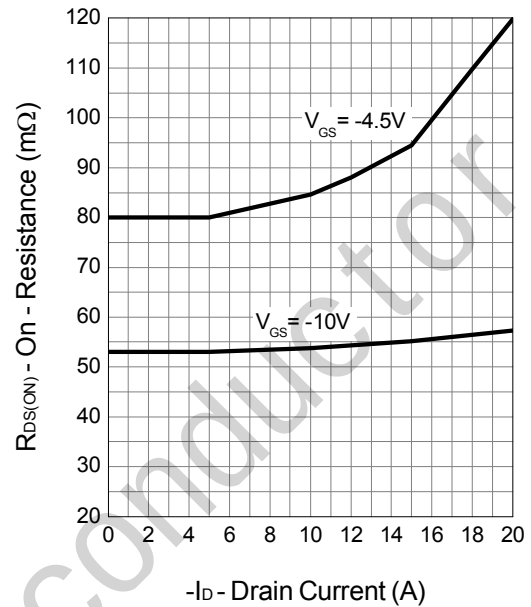


## Typical Characteristics (Cont.)

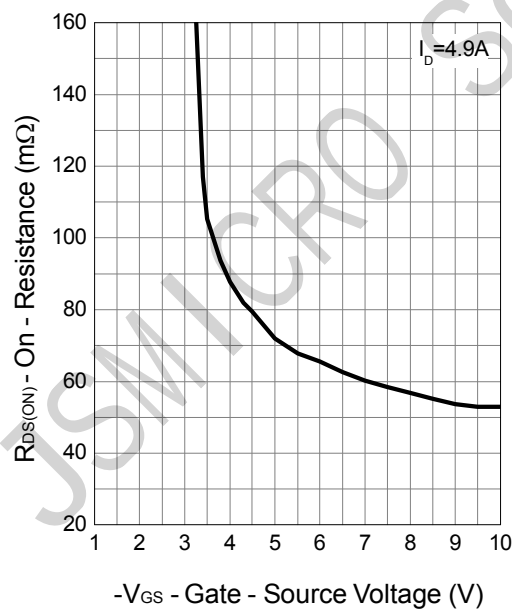
Output Characteristics



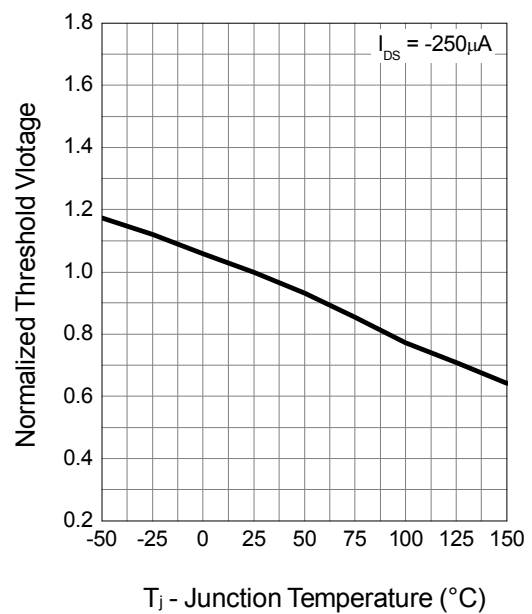
Drain-Source On Resistance



Drain-Source On Resistance

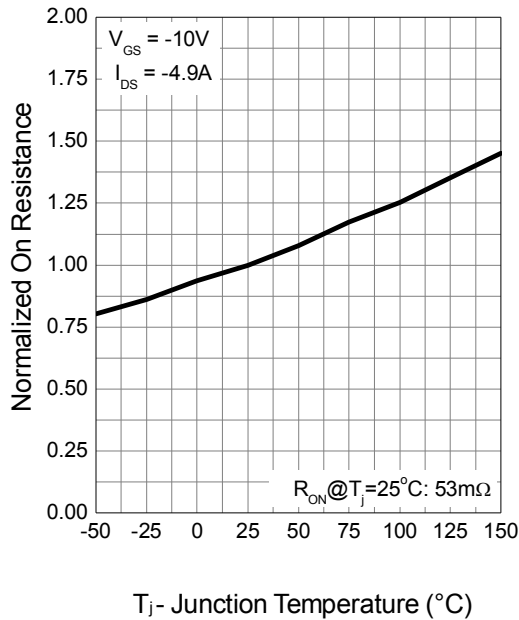


Gate Threshold Voltage

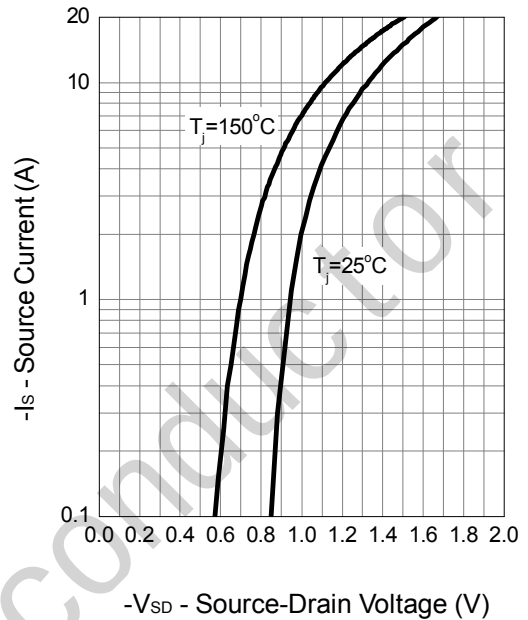


## Typical Characteristics (Cont.)

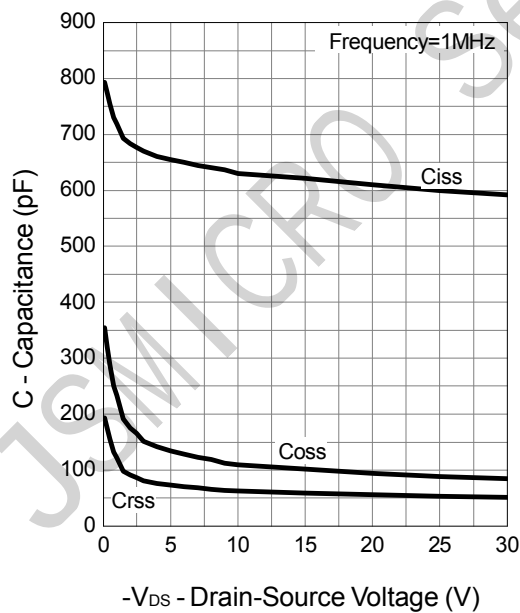
Drain-Source On Resistance



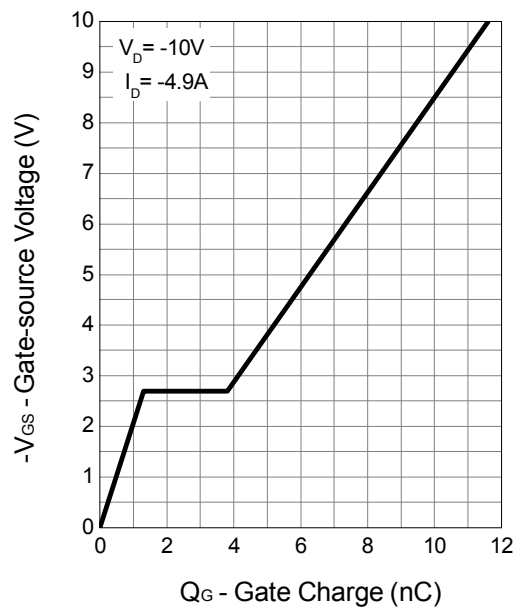
Source-Drain Diode Forward



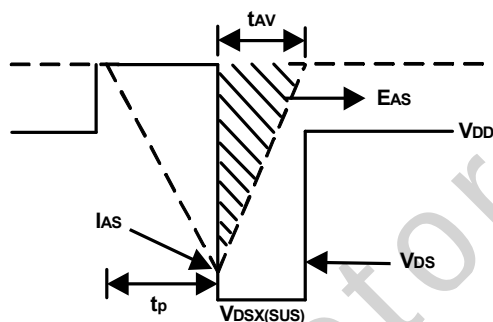
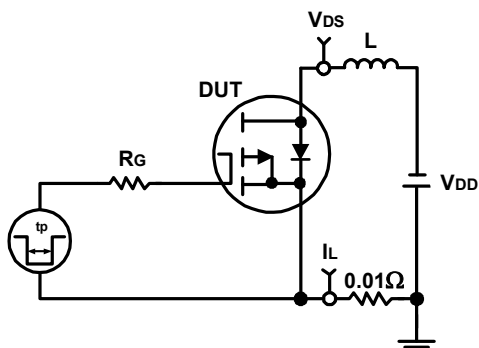
Capacitance



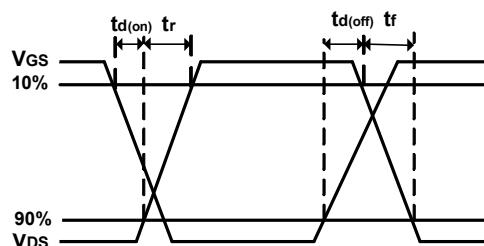
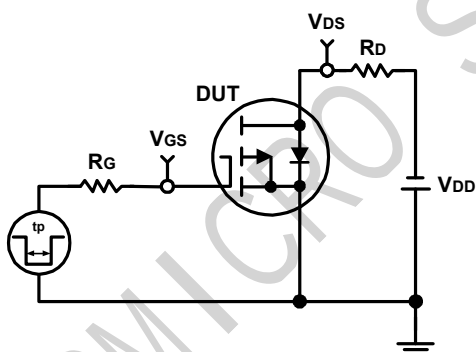
Gate Charge



## Avalanche Test Circuit and Waveforms

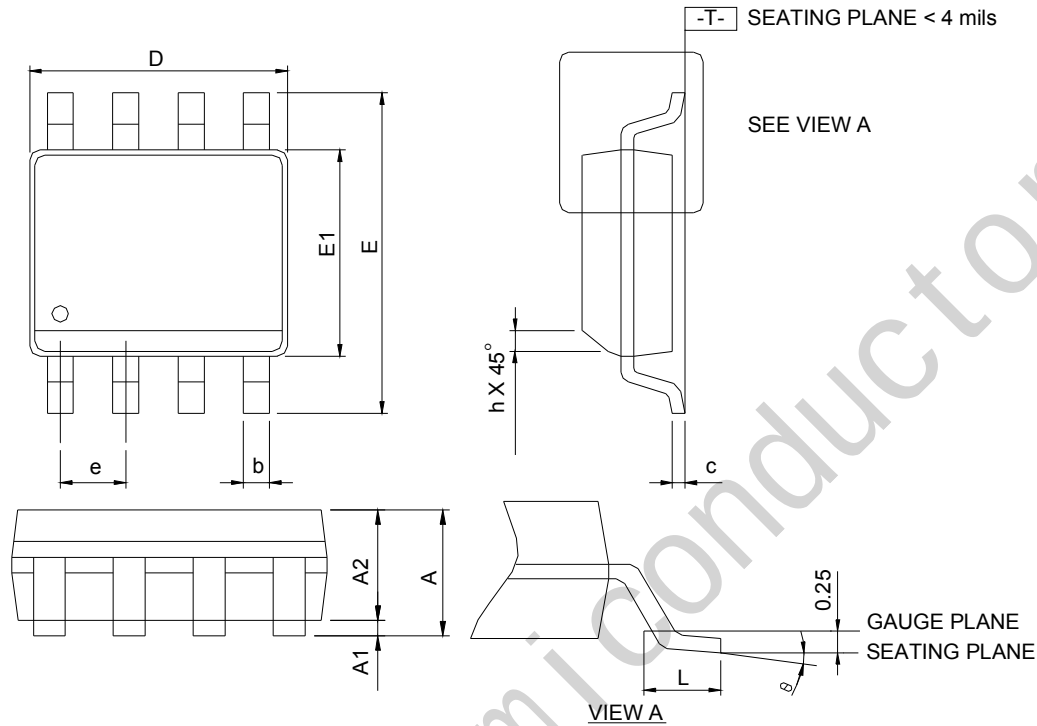


## Switching Time Test Circuit and Waveforms



## Package Information

### SOP-8



| DIMENSIONS | SOP-8       |      |           |       |
|------------|-------------|------|-----------|-------|
|            | MILLIMETERS |      | INCHES    |       |
|            | MIN.        | MAX. | MIN.      | MAX.  |
| A          | -           | 1.75 | -         | 0.069 |
| A1         | 0.10        | 0.25 | 0.004     | 0.010 |
| A2         | 1.25        | -    | 0.049     | -     |
| b          | 0.31        | 0.51 | 0.012     | 0.020 |
| c          | 0.17        | 0.25 | 0.007     | 0.010 |
| D          | 4.80        | 5.00 | 0.189     | 0.197 |
| E          | 5.80        | 6.20 | 0.228     | 0.244 |
| E1         | 3.80        | 4.00 | 0.150     | 0.157 |
| e          | 1.27 BSC    |      | 0.050 BSC |       |
| h          | 0.25        | 0.50 | 0.010     | 0.020 |
| L          | 0.40        | 1.27 | 0.016     | 0.050 |
| θ          | 0°          | 8°   | 0°        | 8°    |

Note: 1. Follow JEDEC MS-012 AA.

2. Dimension "D" does not include mold flash, protrusions or gate burrs.  
Mold flash, protrusion or gate burrs shall not exceed 6 mil per side.

3. Dimension "E" does not include inter-lead flash or protrusions.  
Inter-lead flash and protrusions shall not exceed 10 mil per side.

### RECOMMENDED LAND PATTERN

